

# MC12026ADG Datasheet



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DiGi Electronics Part Number MC12026ADG-DG

Manufacturer onsemi

Manufacturer Product Number MC12026ADG

Description IC PRESCALER 8SOIC

Detailed Description Prescaler IC 1.1GHz 1 8-SOIC (0.154", 3.90mm Widt

h)



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

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### **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
MC12026ADG	onsemi
Series:	Product Status:
	Active
DiGi-Electronics Programmable:	Type:
Not Verified	Prescaler
PLL:	Input:
No	CMOS, TTL
Output:	Number of Circuits:
ECL	1
Ratio - Input:Output:	Differential - Input:Output:
1:1	No/No
Frequency - Max:	Divider/Multiplier:
1.1GHz	Yes/No
Voltage - Supply:	Operating Temperature:
4.5V ~ 5.5V	-40°C ~ 85°C
Mounting Type:	Package / Case:
Surface Mount	8-SOIC (0.154", 3.90mm Width)
Supplier Device Package:	Base Product Number:
8-SOIC	MC12026

### **Environmental & Export classification**

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	

8542.39.0001

## Onsemi

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### 1.1 GHz Dual Modulus Prescaler MC12026A

### Description

The MC12026A is a high frequency, low voltage dual modulus prescaler used in phase-locked loop (PLL) applications.

The MC12026A can be used with CMOS synthesizers requiring positive edges to trigger internal counters in a PLL to provide tuning signals up to 1.1 GHz in programmable frequency steps.

A Divide Ratio Control (SW) permits selection of an 8/9 or 16/17 divide ratio as desired.

The Modulus Control (MC) selects the proper divide number after SW has been biased to select the desired divide ratio.

#### **Features**

- 1.1 GHz Toggle Frequency
- Supply Voltage 4.5 to 5.5 V
- Low Power 4.0 mA Typical
- Operating Temperature Range of -40 to 85°C
- The MC12026 is Pin Compatible with the MC12022
- Short Setup Time (t<sub>set</sub> ) 6.0 ns Typical @ 1.1 GHz
- Modulus Control Input Level is Compatible with Standard CMOS and TTL
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

Table 1. FUNCTIONAL TABLE

sw	МС	Divide Ratio
Н	Н	8
Н	L	9
L	Н	16
L	L	17

SW: H = V<sub>CC</sub>, L = Open. A logic L can also be applied by grounding this pin, but this is not recommended due to increased power consumption.

#### **Table 2. MAXIMUM RATINGS**

Characteristics Symbol		Value	Unit
Power Supply Voltage, Pin 2	V <sub>CC</sub>	-0.5 to 7.0	Vdc
Operating Temperature Range	T <sub>A</sub>	-40 to 85	°C
Storage Temperature Range T <sub>stg</sub>		-65 to 150	°C
Modulus Control Input, Pin 6	MC	-0.5 to 6.5	Vdc
Maximum Output Current, Pin 4	I <sub>O</sub>	10.0	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1

NOTE: ESD data available upon request.



SOIC-8 NB D SUFFIX CASE 751-07

#### **MARKING DIAGRAM**

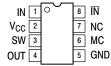


= Assembly Location

L = Wafer Lot Y = Year W = Work Week • Pb-Free Package

(Note: Microdot may be in either location)

#### **PIN CONNECTIONS**



(Top View)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC12026ADR2G	SOIC-8 NB (Pb-Free)	2500 / Tape & Reel

#### **DISCONTINUED** (Note 1)

MC12026ADG	SOIC-8 NB (Pb-Free)	98 Units/Tube

- †For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
- DISCONTINUED: This device is not recommended for new design. Please contact your onsemi representative for information. The most current information on this device may be available on www.onsemi.com.

<sup>2.</sup> MC: H = 2.0 V to  $V_{CC}$ , L = GND to 0.8 V.

<sup>\*</sup>For additional marking information, refer to Application Note <u>AND8002/D</u>.

Table 3. ELECTRICAL CHARACTERISTICS ( $V_{CC} = 4.5 \text{ to } 5.5$ ;  $T_A = -40 \text{ to } 85^{\circ}\text{C}$ , unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
Toggle Frequency (Sin Wave)	f <sub>t</sub>	0.1	1.4	1.1	GHz
Supply Current Output Unloaded (Pin 2)	I <sub>CC</sub>	-	4.0	5.3	mA
Modulus Control Input High (MC)	V <sub>IH1</sub>	2.0	=	V <sub>CC</sub>	V
Modulus Control Input Low (MC)	V <sub>IL1</sub>	GND	=	0.8	V
Divide Ratio Control Input High (SW)	V <sub>IH2</sub>	V <sub>CC</sub> – 0.5 V	$V_{CC}$	V <sub>CC</sub> + 0.5 V	V
Divide Ratio Control Input Low (SW)	V <sub>IL2</sub>	OPEN	OPEN	OPEN	-
Output Voltage Swing (R <sub>L</sub> = 560 $\Omega$ ; I <sub>O</sub> = 5.5 mA) (Note 1) (R <sub>L</sub> = 1.1 k $\Omega$ ; I <sub>O</sub> = 2.9 mA) (Note 2)	V <sub>out</sub>	1.0	1.6	-	V <sub>pp</sub>
Modulus Setup Time MC to Out (Note 3)	t <sub>SET</sub>	-	6.0	9.0	ns
Input Voltage Sensitivity 100-250 MHz 250-1100 MHz	V <sub>in</sub>	400 100	- -	1000 1000	mVpp

- 1. Divide Ratio of  $\div 8/9$  at 1.1 GHz,  $C_L=8.0$  pF. 2. Divide Ratio of  $\div 16/17$  at 1.1 GHz,  $C_L=8.0$  pF. 3. Assuming  $R_L=560$   $\Omega$  at 1.1 GHz.

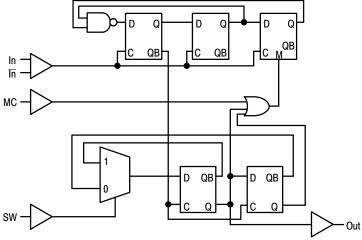
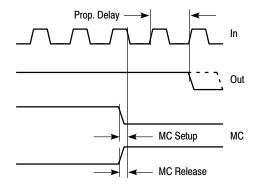


Figure 1. Logic Diagram (MC12026A)



Modulus setup time MC to out is the MC setup or MC release plus the prop delay.

Figure 2. Modulus Setup Time

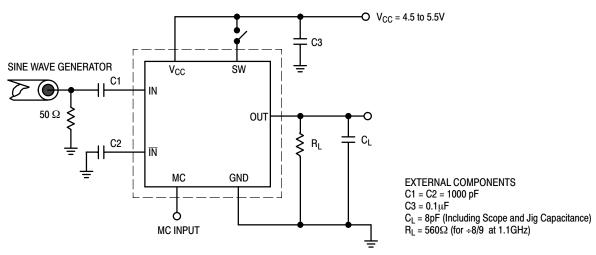


Figure 3. AC Test Circuit

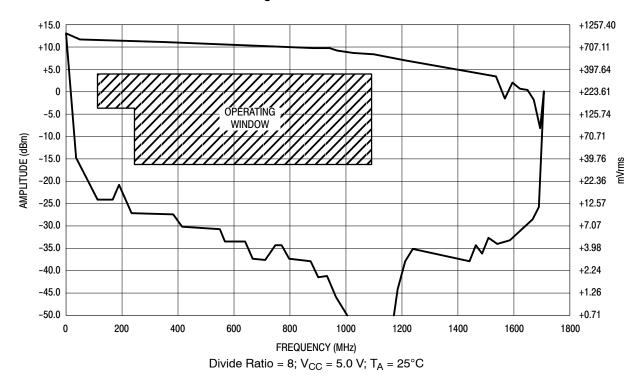


Figure 4. Input Signal Amplitude Versus Input Frequency

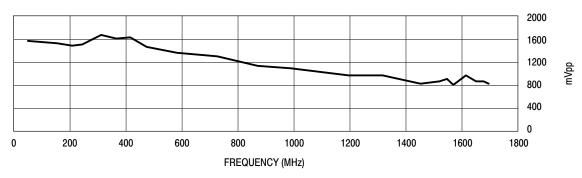
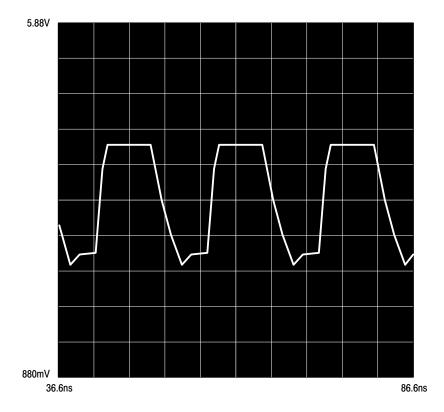


Figure 5. Output Amplitude Versus Input Frequency



( $\div$ 8, 1.1 GHz Input Frequency,  $V_{CC}$  = 5.0,  $T_A$  = 25°C, Output Loaded With 8.0pF)

Figure 6. Typical Output Waveform

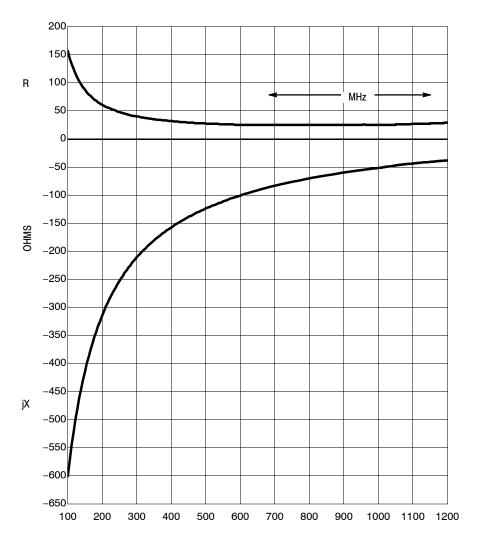


Figure 7. Typical Input Impedance Versus Input Frequency



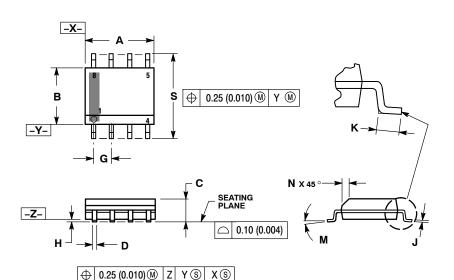
### **MECHANICAL CASE OUTLINE**

PACKAGE DIMENSIONS



SOIC-8 NB CASE 751-07 **ISSUE AK** 

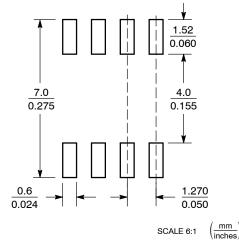
**DATE 16 FEB 2011** 



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.80	5.00	0.189	0.197
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
Н	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
М	0 °	8 °	0 °	8 °
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

#### **SOLDERING FOOTPRINT\***



<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code = Assembly Location = Wafer Lot

= Year = Work Week = Pb-Free Package

XXXXXX XXXXXX AYWW AYWW H  $\mathbb{H}$ Discrete **Discrete** (Pb-Free)

XXXXXX = Specific Device Code = Assembly Location Α

ww = Work Week = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

#### **STYLES ON PAGE 2**

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#### SOIC-8 NB CASE 751-07 ISSUE AK

#### **DATE 16 FEB 2011**

STYLE 1: PIN 1. EMITTER 2. COLLECTOR 3. COLLECTOR 4. EMITTER 5. EMITTER 6. BASE 7. BASE 8. EMITTER	STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 3. COLLECTOR, #2 4. COLLECTOR, #2 5. BASE, #2 6. EMITTER, #2 7. BASE, #1 8. EMITTER, #1	STYLE 3: PIN 1. DRAIN, DIE #1 2. DRAIN, #1 3. DRAIN, #2 4. DRAIN, #2 5. GATE, #2 6. SOURCE, #2 7. GATE, #1 8. SOURCE, #1	STYLE 4: PIN 1. ANODE 2. ANODE 3. ANODE 4. ANODE 5. ANODE 6. ANODE 7. ANODE 8. COMMON CATHODE
STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN 4. DRAIN 5. GATE 6. GATE 7. SOURCE 8. SOURCE	7. BASE, #1 8. EMITTER, #1  STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN 4. SOURCE 5. SOURCE 6. GATE 7. GATE 8. SOURCE	STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS 3. THIRD STAGE SOURCE 4. GROUND 5. DRAIN 6. GATE 3 7. SECOND STAGE Vd 8. FIRST STAGE Vd	STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 3. BASE, #2
STYLE 9: PIN 1. EMITTER, COMMON 2. COLLECTOR, DIE #1 3. COLLECTOR, DIE #2 4. EMITTER, COMMON 5. EMITTER, COMMON 6. BASE, DIE #2 7. BASE, DIE #1 8. EMITTER, COMMON	STYLE 10: PIN 1. GROUND 2. BIAS 1 3. OUTPUT 4. GROUND 5. GROUND 6. BIAS 2 7. INPUT 8. GROUND	STYLE 11: PIN 1. SOURCE 1 2. GATE 1 3. SOURCE 2 4. GATE 2 5. DRAIN 2 6. DRAIN 2 7. DRAIN 1 8. DRAIN 1	STYLE 12: PIN 1. SOURCE 2. SOURCE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN
STYLE 13: PIN 1. N.C. 2. SOURCE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN	STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3. P-SOURCE 4. P-GATE 5. P-DRAIN 6. P-DRAIN 7. N-DRAIN 8. N-DRAIN	STYLE 15:  PIN 1. ANODE 1 2. ANODE 1 3. ANODE 1 4. ANODE 1 5. CATHODE, COMMON 6. CATHODE, COMMON 7. CATHODE, COMMON 8. CATHODE, COMMON	STYLE 16:  PIN 1. EMITTER, DIE #1 2. BASE, DIE #1 3. EMITTER, DIE #2 4. BASE, DIE #2 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 7. COLLECTOR, DIE #1 8. COLLECTOR, DIE #1
STYLE 17: PIN 1. VCC 2. V2OUT 3. V1OUT 4. TXE 5. RXE 6. VEE 7. GND 8. ACC	STYLE 18: PIN 1. ANODE 2. ANODE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. CATHODE 8. CATHODE	STYLE 19: PIN 1. SOURCE 1 2. GATE 1 3. SOURCE 2 4. GATE 2 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 8. MIRROR 1	STYLE 20: PIN 1. SOURCE (N) 2. GATE (N) 3. SOURCE (P) 4. GATE (P) 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN
5. RXE 6. VEE 7. GND 8. ACC STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3. CATHODE 3 4. CATHODE 4 5. CATHODE 5 6. COMMON ANODE 7. COMMON ANODE 8. CATHODE 6	STYLE 22: PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3. COMMON CATHODE/VCC 4. I/O LINE 3 5. COMMON ANODE/GND 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GND	STYLE 23: PIN 1. LINE 1 IN 2. COMMON ANODE/GND 3. COMMON ANODE/GND 4. LINE 2 IN 5. LINE 2 OUT 6. COMMON ANODE/GND 7. COMMON ANODE/GND 8. LINE 1 OUT	STYLE 24: PIN 1. BASE 2. EMITTER 3. COLLECTOR/ANODE 4. COLLECTOR/ANODE 5. CATHODE 6. CATHODE 7. COLLECTOR/ANODE 8. COLLECTOR/ANODE
STYLE 25: PIN 1. VIN 2. N/C 3. REXT 4. GND 5. IOUT 6. IOUT 7. IOUT 8. IOUT	STYLE 26: PIN 1. GND 2. dv/dt 3. ENABLE 4. ILIMIT 5. SOURCE 6. SOURCE 7. SOURCE 8. VCC	STYLE 27: PIN 1. ILIMIT 2. OVLO 3. UVLO 4. INPUT+ 5. SOURCE 6. SOURCE 7. SOURCE 8. DRAIN	STYLE 28: PIN 1. SW_TO_GND 2. DASIC_OFF 3. DASIC_SW_DET 4. GND 5. V MON 6. VBULK 7. VBULK 8. VIN
STYLE 29: PIN 1. BASE, DIE #1 2. EMITTER, #1 3. BASE, #2 4. EMITTER, #2 5. COLLECTOR, #2 6. COLLECTOR, #2 7. COLLECTOR, #1 8. COLLECTOR, #1	STYLE 30: PIN 1. DRAIN 1 2. DRAIN 1 3. GATE 2 4. SOURCE 2 5. SOURCE 1/DRAIN 2 6. SOURCE 1/DRAIN 2 7. SOURCE 1/DRAIN 2 8. GATE 1		

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